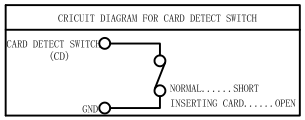
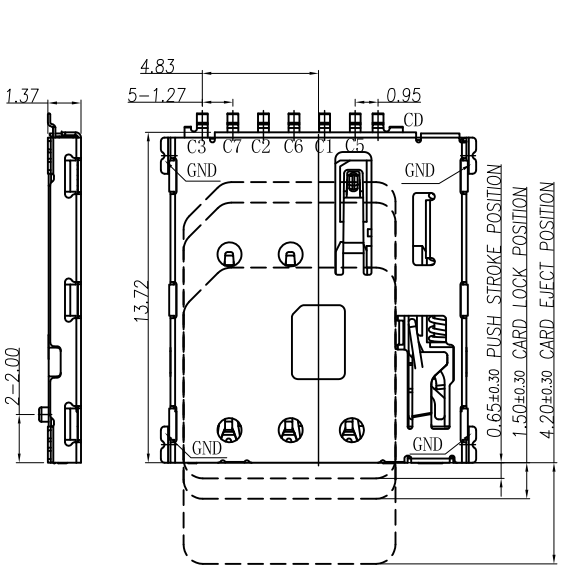
更改 REV	說 明 內 容 MODIFICATION
A	EC05998
B	EC06855
C	EC07053





RECOMMENDED PCB LAYOUT

TOLERANCE: ±0.05

SMT SOLDER AREA

COPPER RESTRICTED AREA

1. TOUCH AREA OF CONTACT TIPS NO ELECTRICAL FUNCTION
2. NO FIRST PCB_LAYOUT CIRCUITS IN THE AREA

Notes:

1. Material:
   Housing: High Temperature Thermoplastic
   Terminal:Copper Alloy
   Shell: Stainless Steel
2. Plating:
   Terminal:50u″ Ni Underplated Overall
   G/F Plated On Contact Area
   G/F Plated On Solder Area
   Sheel:30u″ Ni Underplated Overall
   G/F Plated On Contact Area And older Area
3. Technical Speciality:
   Rated Voltage: 30V
   Current Rating: 0.5A
   Insulation Resistance:1000MΩ Min.
   Contact Resistance:100mΩ Max.
   Withstanding Voltage: 500V DC For 1 Minutes.
   Operating Temperature: -40℃～+75℃ Humidity 80% R.H Max.

PIN/NO	ASSIGNMENT
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O
CD	Detect Switch

GENERIAL TOLERANCE	
X.± 0.50	
.X± 0.30	
.XX± 0.20	GND

KINGCONN 皇海科技股份有限公司

名 稱(TITLE): NANO SIM CARD PUSH 7PIN 1.37H 帶CD PIN

單 位(UNIT)	料 號(PART NO.)	圖 號(DWG NO.)
mm	7SIMC-F0-0043	7SIMC-F0-0043-C

審 核(APPROVAL)	核 對(CHECKED)	製 圖(DRAWN)	比 例 SCALE 1:1	張 數 SHEET 1 / 1
			專 案 PROJ.	更 改 REV C

QP-701-03-R